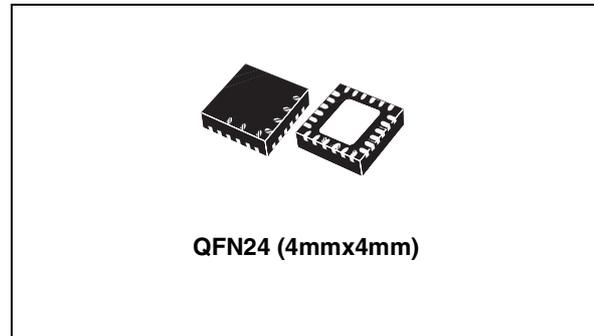


### Feature summary

- Meets the requirements of the universal serial bus specification revision 2.0 And the on-the-go supplement to the USB 2.0 specification
- Analog car kit-compatible
- Three operating modes: USB, UART and audio
- Configurable using I<sup>2</sup>C serial interface
- Capable of 12Mbit/s full-speed and 1.5Mbit/s low-speed modes of operation
- Standard digital interface compliant with the OTG transceiver specification
- Supports the session request protocol (SRP) and host negotiation protocol (HNP)
- 35mA Typical V<sub>BUS</sub> Charge pump output current for 3.3V supply voltage
- Ability to control external charge pump for higher V<sub>BUS</sub> currents
- Integrated pull-up/-down resistors
- ±6kV ESD protection on all USB pins (contact discharge)
- +1.6V to +3.6V Digital power supply and +2.7V to +5.5V analog supply voltage range
- Power-down mode with very low power consumption for battery powered devices
- Ideal for system ASICs with built-in USB OTG dual role core
- Available In QFN-24
- -40°C to +85°C operating temperature range



- MP3 players
- Digital cameras
- Printers

### Description

The STOTG04ES is a USB On-The-Go full-speed transceiver. It provides complete physical layer solution for any USB-OTG device. It contains V<sub>BUS</sub> charge pump and comparators, ID line detector and interrupt generator, and the USB differential driver and receivers. The STOTG04 transceiver is suitable for mobile and battery powered devices because of its low power consumption and power down operating mode.

The transceiver is capable of operation in several different modes. It can operate in basic USB-OTG mode, as an UART transceiver or in audio mode. Behavior of the transceiver is fully configurable through the two-wire I<sup>2</sup>C serial bus. The transceiver supports session request protocol and host negotiation protocol.

### Applications

- Mobile phones
- PDAs

### Order code

Part number	Package	Packaging
STOTG04ESQTR	QFN24 (4mm x 4mm)	4000 parts per reel

## Contents

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# 1 Pin configuration

Figure 1. Pin connections (bottom view )

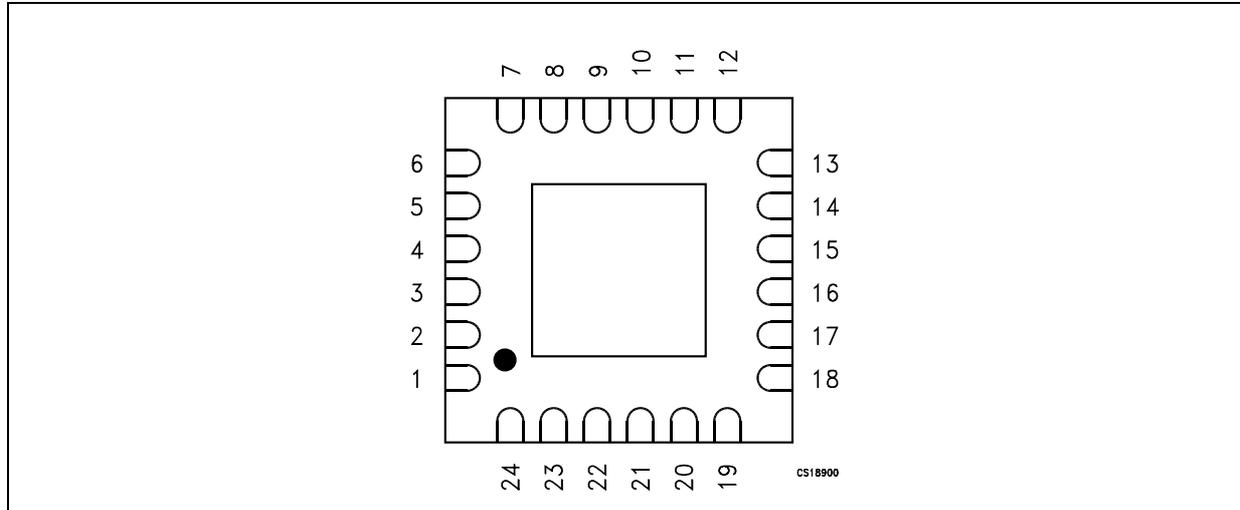


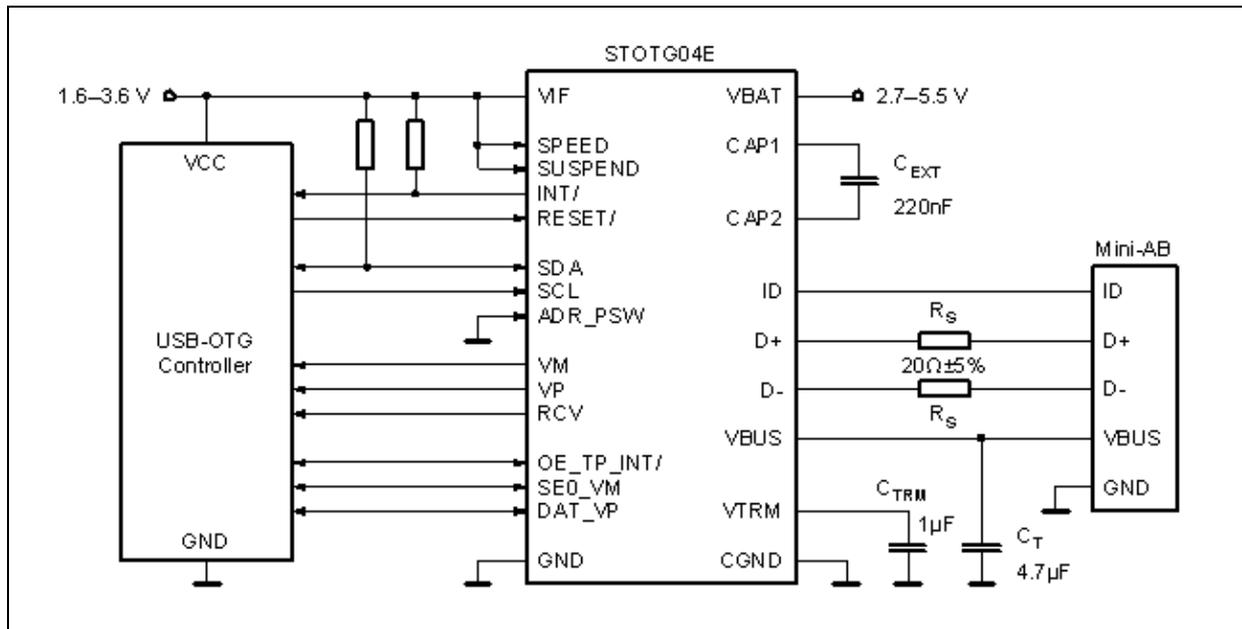
Table 1. Pin description

PIN N°	SYMBOL	I/O	NAME AND FUNCTION
1	ADR_PSW	I/O	Least significant bit of the I <sup>2</sup> C address of the transceiver input latched on reset; PSW output enabling or disabling an external charge pump
2	SDA	I/O	I <sup>2</sup> C serial data (1)
3	SCL	I	I <sup>2</sup> C clock
4	RESET/	I	Active low logic reset
5	INT/	O	Active low interrupt signal (open-drain)
6	SPEED	I	Mode of the transceiver (0 = low-speed, 1 = full-speed) (2)
7	V <sub>TRM</sub>	Power	Internal voltage regulator output; an external decoupling capacitor should be connected (3)
8	SUSPEND	I	Power down input (0 = active mode, 1 = power down) (See <a href="#">Table 8</a> )
9	OE_TP_INT/	I/O	Output enable of the differential driver in the USB mode or interrupt output
10	VM	O	D- single-ended receiver output
11	VP	O	D+ single-ended receiver output
12	RCV	O	Differential receiver output
	ExpPad	-	Not Connected
13	SE0_VM	I/O	Single-ended zero input/output in the DAT_SE0 mode transmit mode, negative data input/output in the single-ended transmit mode or TXD in the UART mode
14	DAT_VP	I/O	Data input/output in the DAT_SE0 mode transmit mode, positive data input/output in the single-ended transmit mode or RXD in the UART mode
15	D-	I/O	Negative data line in the USB mode or serial data output in the UART mode
16	D+	I/O	Positive data line in the USB mode or serial data input in the UART mode
17	GND	Power	Common analog and digital ground
18	ID	I/O	ID pin of the USB connector used for protocol identification
19	V <sub>BUS</sub>	I/O	V <sub>BUS</sub> line of the USB interface – it needs an external capacitor of 4.7µF
20	V <sub>BAT</sub>	Power	Analog power supply voltage (+2.7V to +5.5V)
21	CAP1	I/O	External capacitor pin for the charge pump
22	CAP2	I/O	External capacitor pin for the charge pump

PIN N°	SYMBOL	I/O	NAME AND FUNCTION
23	CGND	Power	Ground for the charge pump
24	V <sub>IF</sub>	Power	Logic power supply (+1.6V to 3.6V)

- (1) Input and open-drain output
- (2) Input with internal pull-up resistor
- (3) Internal regulator can be bypassed by connecting V<sub>BAT</sub> to this pin when the V<sub>BAT</sub> is in range of 2.7V to 3.6V

Figure 2. Functional diagram



## 2 Maximum ratings

**Table 2. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
V <sub>IF</sub>	Logic Supply Voltage	-0.5 to + 4.5	V
V <sub>BAT</sub>	Analog Supply Voltage	-0.5 to + 6.5	V
V <sub>DCDIG</sub>	DC Input Voltage on any logic interface pin	-0.5 to + 4.5	V
T <sub>STG</sub>	Storage Temperature Range	-65 to + 150	°C
V <sub>ESD</sub>	Electrostatic discharge voltage on USB pins	Human Body Model	± 8
		Contact Discharge (*)	± 6

(\*) In accordance to IEC61000-4-2, level 3.

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional Operation under these conditions is not implied.

**Table 3. Thermal data**

Symbol	Parameter	Value	Unit
R <sub>thJA</sub>	Thermal Resistance Junction-Ambient	59	°C/W

**Table 4. Recommended operating condition**

Symbol	Parameter	Min.	Typ.	Max.	Unit
V <sub>IF</sub>	Logic Supply Voltage	1.6	1.8	3.6	V
V <sub>BAT</sub>	Analog Supply Voltage	2.7	3.3	5.5	V
T <sub>A</sub>	Operating Temperature Range	-40		+85	°C
C <sub>EXT</sub>	Charge pump external capacitor	100	220	470	nF
C <sub>T</sub>	Charge pump tank capacitor	1	4.7	6.5	µF
C <sub>TRM</sub>	Voltage regulator external capacitor		1		µF
R <sub>S</sub>	Data lines impedance matching resistor		20		Ω

**Table 5. ESD Performance**

Symbol	Parameter	Value	Unit
ESD	IEC-61000-4-2 (D+, D-, VBUS, ID)	Air discharge (10 pulses)	± 8
		Contact discharge (10 pulses)	± 6
	IEC-61000-4-2 (other pins)	Air discharge (10 pulses)	± 2
		Contact discharge (10 pulses)	± 2

### 3 Electrical characteristics

**Table 6. Electrical characteristics**

Characteristics measured over recommended operating conditions unless otherwise is noted. All typical values are referred to  $T_A = 25^\circ\text{C}$ ,  $V_{IF} = 1.8\text{V}$ ,  $V_{BAT} = 3.3\text{V}$ ,  $R_S = 20\Omega$ ,  $C_{EXT} = 220\text{nF}$ ,  $C_T = 4.7\mu\text{F}$  and  $C_{TRM} = 1\mu\text{F}$

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$I_{IF}$	Digital Part Supply Current	Active mode (1,2)		0.6	1.6	mA
		Power down mode			1	$\mu\text{A}$
$I_{BAT}$	Operating Supply Current	Transceiver current while transmitting and receiving (1,2)		4.5	7	mA
		Charge pump current, $I_{LOAD} = 8\text{mA}$		17	25	
		Power down mode (3)			1	$\mu\text{A}$
<b>LOGIC INPUTS AND OUTPUTS</b>						
$V_{OH}$	HIGH level output voltage	$I_{OH} = -100\mu\text{A}$	$V_{IF}-0.15$			V
		$I_{OH} = -2\text{mA}$	$V_{IF}-0.40$			V
$V_{OL}$	LOW level output voltage	$I_{OL} = 100\mu\text{A}$			0.15	V
		$I_{OL} = 2\text{mA}$			0.40	V
$V_{IH}$	HIGH level input voltage		$0.7V_{IF}$			V
$V_{IL}$	LOW level input voltage				$0.3V_{IF}$	V
$I_{LKG}$	Input leakage current		-1		1	$\mu\text{A}$
$I_{OZ}$	Off-state output current		-5		5	$\mu\text{A}$
<b><math>V_{BUS}</math></b>						
$V_{BUS}$	$V_{BUS}$ output voltage	$I_{LOAD} = 8\text{mA}$	4.4	4.9	5.25	V
$V_{BUS\_LKG}$	$V_{BUS}$ leakage voltage	No Load		3	200	mV
$V_{BUS\_RIP}$	$V_{BUS}$ output ripple	$I_{LOAD} = 8\text{mA}$ , $C_T = 4.7\mu\text{F}$		30	60	mV
$f_{CP}$	Charge-pump switching frequency (2)		0.5	0.8	1.5	MHz
$R_{VBUS}$	$V_{BUS}$ input impedance		40	76	100	k $\Omega$
$I_{VBUS}$	Maximum $V_{BUS}$ source current	$C_{EXT} = 220\text{ nF}$ , $V_{BUS} > 4.4\text{V}$	20	35		mA
$V_{BUS\_VLD}$	$V_{BUS}$ valid comparator threshold	Low to high transition	4.40			V
		High to low transition	4.40			
$V_{SES\_VLD}$	Session valid comparator threshold for both A and B devices	Low to high transition	0.8		2.0	V
		High to low transition	0.8		2.0	
$R_{VBUS\_PU}$	$V_{BUS}$ charge pull-up resistance		281	640		$\Omega$
$R_{VBUS\_PD}$	$V_{BUS}$ discharge pull-down resistance		656	1260		$\Omega$
<b>ID</b>						
$V_{ID\_BIAS}$	ID pin bias voltage	$R_{CP\_ID} = 140\text{k}\Omega$ , $V_{BAT} \leq 5\text{V}$	1.3	1.9	3.0	V
$R_{ID\_PU}$	ID pin pull-up resistance		70	105	130	k $\Omega$
$R_{ID\_GND}$	ID line short resistance to detect id_gnd state				10	$\Omega$
$R_{ID\_FLOAT}$	ID line short resistance to detect id_float state		800			k $\Omega$

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>DIFFERENTIAL DRIVER</b>						
Z <sub>DRV</sub>	Output Impedance	Excluding external R <sub>S</sub>	8	16	24	Ω
V <sub>OH_DRV</sub>	HIGH level output voltage	R <sub>LH</sub> = 14.25kΩ, V <sub>TRM</sub> = 3.3V	2.8		3.6	V
		R <sub>LH</sub> = 14.25kΩ, V <sub>TRM</sub> = 2.7V	2.6		3.0	V
V <sub>OL_DRV</sub>	LOW level output voltage	R <sub>LL</sub> = 1.425kΩ	0		0.3	V
V <sub>CRS</sub>	Driver crossover voltage	C <sub>LOAD</sub> = 50 to 600pF	1.3	1.67	2.0	V
<b>DIFFERENTIAL AND SINGLE-ENDED RECEIVERS</b>						
V <sub>DI</sub>	Differential receiver input sensitivity (V <sub>D+</sub> - V <sub>D-</sub> )	V <sub>CM</sub> = 0.8 to 2.5V	-200		200	mV
V <sub>SE-TH</sub>	SE receivers switching threshold	Low to high transition	0.8	1.6	2.0	V
		High to low transition	0.8	1.1	2.0	
R <sub>IN</sub>	Input resistance	PU/PD resistor deactivated	1.5			MΩ
C <sub>IN</sub>	Input capacitance			10	30	pF
R <sub>PU_D+</sub>	Data line pull-up resistance on pin D+	Bus Idle	900	1300	1575	Ω
		Receiving mode	1425	2200	3090	
R <sub>PU_D-</sub>	Data line pull-up resistance on pin D-		900	1300	1575	Ω
R <sub>PD</sub>	Data line pull-down resistance		14.25	17.0	24.8	kΩ
V <sub>DT_LKG</sub>	Data line leakage voltage	R <sub>PU_EXT</sub> = 300kΩ		200	342	mV
<b>CAR KIT INTERRUPT DETECTOR</b>						
V <sub>CR_INT_TH</sub>	Car kit Interrupt threshold		0.4		0.6	V
<b>UART MODE – D+ AND D- PINS</b>						
V <sub>OH</sub>	HIGH level output voltage	I <sub>OH</sub> = -2mA	2.4		3.6	V
V <sub>OL</sub>	LOW level output voltage	I <sub>OL</sub> = 2mA	0		0.4	V
V <sub>IH</sub>	HIGH level input voltage		2.0			V
V <sub>IL</sub>	LOW level input voltage				0.8	V
<b>VOLTAGE REGULATOR</b>						
V <sub>TRM</sub>	Internal power supply voltage	V <sub>BAT</sub> = 3.3 to 5V, no load; uart_en=0	3.0	3.3	3.6	V
		V <sub>BAT</sub> = 2.8 to 5V, no load; uart_en=1	2.6	2.75	2.9	V
I <sub>TRM</sub>	Voltage regulator output current	V <sub>BAT</sub> = 3.6V, V <sub>TRM</sub> > 3V; uart_en=0			20	mA
		V <sub>BAT</sub> = 3.0V, V <sub>TRM</sub> > 2.6V; uart_en=1			10	mA

(1) Transmitting and receiving at 12Mbit/s, loads of 50pF on D+ and D- pins, no capacitive loads on VP and VM pins

(2) Not tested in production; characterization only

(3) See paragraph 6.7.1

**Table 7. Switching characteristics**

Over recommended operating conditions unless otherwise is noted. All the typical values are referred to  $T_A = 25^\circ\text{C}$ ,  $V_{IF} = 1.8\text{V}$ ,  $V_{BAT} = 3.3\text{V}$ ,  $R_S = 20\Omega$ ,  $C_{EXT} = 220\text{nF}$ ,  $C_T = 4.7\mu\text{F}$ , and  $C_{TRM} = 1\mu\text{F}$

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$T_{VBUS\_RISE}$	$V_{BUS}$ rise time	$I_{LOAD} = 8\text{mA}$ , $C_T = 10\mu\text{F}$		1	100	ms
<b>DIFFERENTIAL DRIVER</b>						
$t_R$	Data signal rise time	Full-speed mode, $C_{LOAD} = 50\text{pF}$	4	8.5	20	ns
		Low-speed mode, $C_{LOAD} = 600\text{pF}$	75	110	300	
$t_F$	Data signal rise time	Full-speed mode, $C_{LOAD} = 50\text{pF}$	4	8.5	20	ns
		Low-speed mode, $C_{LOAD} = 600\text{pF}$	75	110	300	
$t_{P\_DRV\_R}$	Propagation delay of the driver, rising edge; DAT_SE0 mode	Full-speed mode, $C_{LOAD} = 50\text{pF}$			38	ns
		Low-speed mode, $C_{LOAD} = 600\text{pF}$			280	
$t_{P\_DRV\_R}$	Propagation delay of the driver, rising edge; VP_VM mode	Full-speed mode, $C_{LOAD} = 50\text{pF}$			55	ns
		Low-speed mode, $C_{LOAD} = 600\text{pF}$			300	
$t_{P\_DRV\_F}$	Propagation delay of the driver, falling edge; DAT_SE0 mode	Full-speed mode, $C_{LOAD} = 50\text{pF}$			38	ns
		Low-speed mode, $C_{LOAD} = 600\text{pF}$			280	
$t_{P\_DRV\_F}$	Propagation delay of the driver, rising edge; VP_VM mode	Full-speed mode, $C_{LOAD} = 50\text{pF}$			55	ns
		Low-speed mode, $C_{LOAD} = 600\text{pF}$			300	
$t_{RFM}$	Rise and fall time matching ( $t_R/t_F$ ) excluding the first transition from the idle state	Full-speed mode	90		111.11	%
		Low-speed mode	80		125	
<b>SINGLE-ENDED RECEIVERS</b>						
$t_{P\_SE\_R}$	Propagation delay of the SE receiver, rising edge	Full-speed mode, input slope 15ns			18	ns
		Low-speed mode, input slope 150ns			18	
$t_{P\_SE\_F}$	Propagation delay of the SE receiver, falling edge	Full-speed mode, input slope 15ns			18	ns
		Low-speed mode, input slope 150ns			18	
<b>DIFFERENTIAL RECEIVER</b>						
$t_{P\_DIF\_R}$	Propagation delay of the SE receiver, rising edge	Full-speed mode, input slope 15ns			24	ns
		Low-speed mode, input slope 150ns			24	
$t_{P\_DIF\_F}$	Propagation delay of the SE receiver, falling edge	Full-speed mode, input slope 15ns			24	ns
		Low-speed mode, input slope 150ns			24	
<b>DIGITAL INTERFACE</b>						
$t_{SET\_OE}$	Output enable setup time		50			ns
$t_{TA\_OI}$	Output to input bus turnaround time (1, 2)		0		5	ns
$t_{TA\_IO}$	Output to input bus turnaround time (1, 2)		0		5	ns
<b>I<sup>2</sup>C BUS (3)</b>						
$f_{SCL}$	SCL clock frequency				100	kHz
$t_{LOW}$	Low period of the SCL clock		4.7			$\mu\text{s}$
$t_{HIGH}$	High period of the SCL clock		4.0			$\mu\text{s}$
$t_{ICR}$	Rise time of both SDA and SCL signals				1000	ns

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_{\text{ICF}}$	Fall time of both SDA and SCL signals				300	ns
$t_{\text{SU\_STA}}$	Setup time for a repeated START condition		4.7			$\mu\text{s}$
$t_{\text{HD\_STA}}$	Hold time for the START and repeated START conditions		4.0			$\mu\text{s}$
$t_{\text{SU\_DAT}}$	Data setup time		250			ns
$t_{\text{HD\_DAT}}$	Data hold time		0			$\mu\text{s}$
$t_{\text{SU\_STO}}$	Setup time for the STOP condition		4.0			$\mu\text{s}$
$t_{\text{BUF}}$	Bus free time between a STOP and START condition		4.7			$\mu\text{s}$

NOTE 1: Parameter applies to the OE\_TP\_INT/, DAT\_VP, and SE0\_VM signals

NOTE 2: Not tested in production; characterization only

NOTE 3: Requirements defined by the I2C-Bus Specification, version 2.1

# 4 Charge pump characteristics

Figure 3. Output characteristics

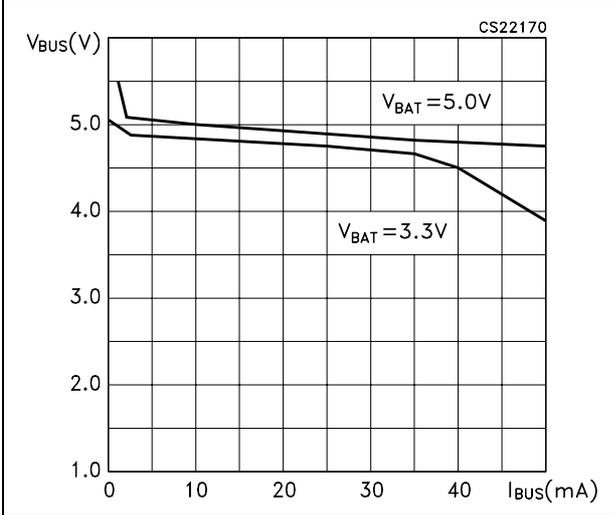
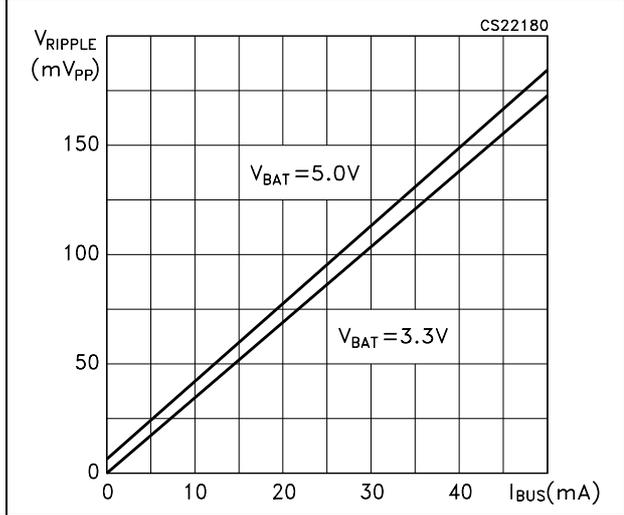


Figure 4. Output ripple



## 5 Timing diagrams

Figure 5. Rise and fall times

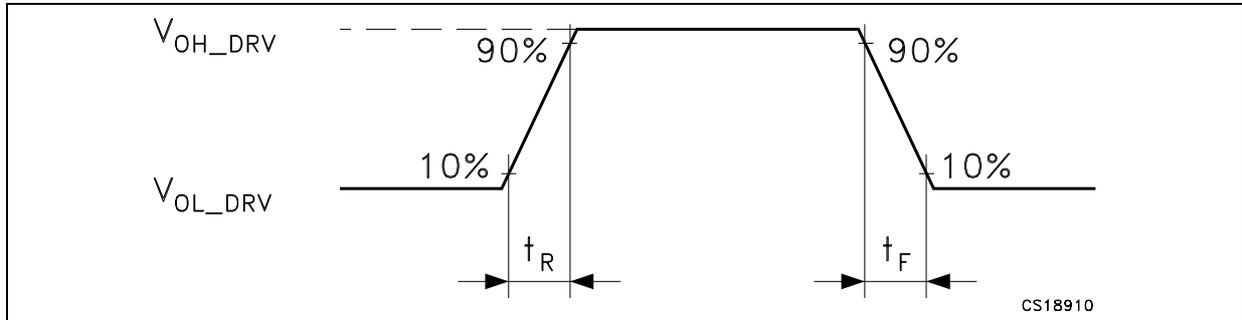


Figure 6. Differential driver propagation delay

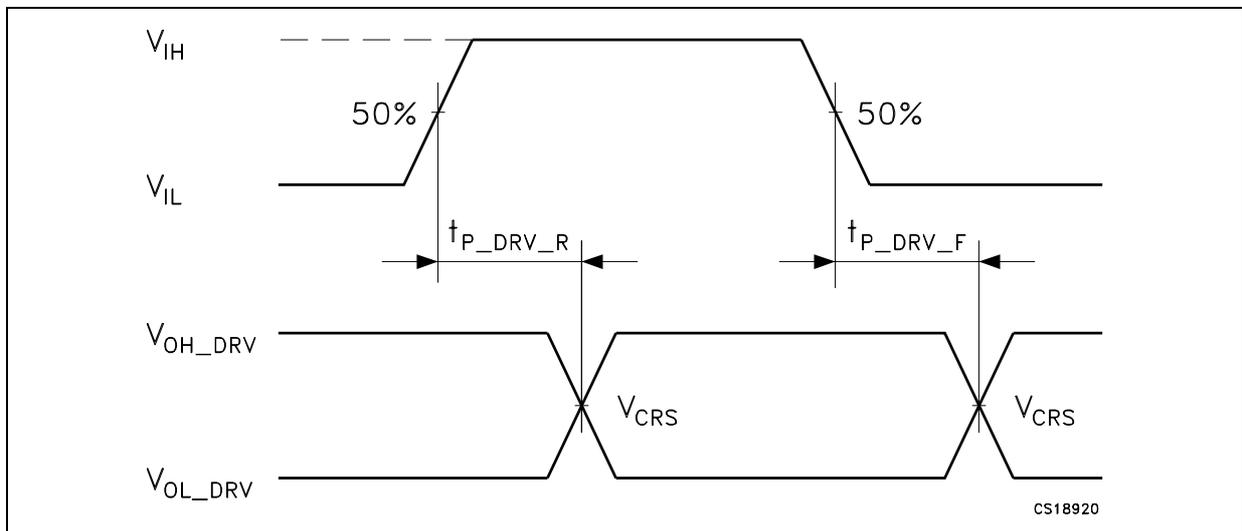


Figure 7. Differential receiver propagation delay

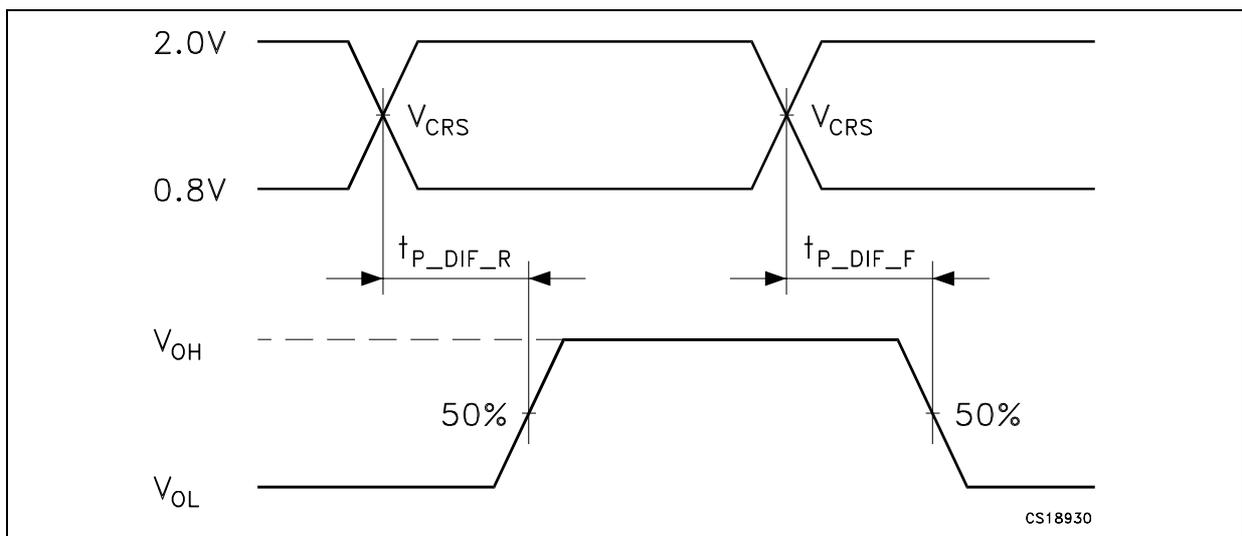


Figure 8. Output enable setup time

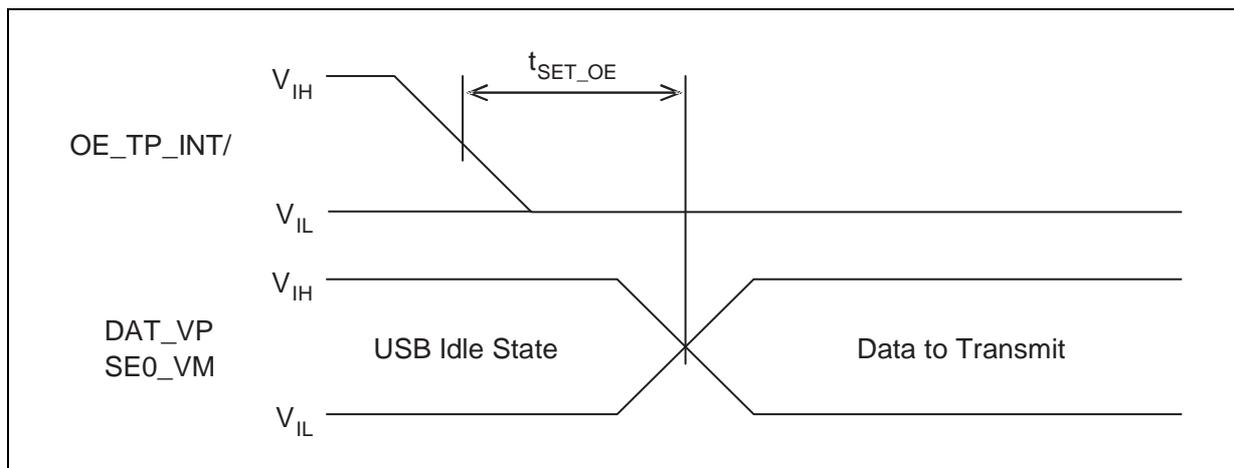


Figure 9. Bus turnaround time

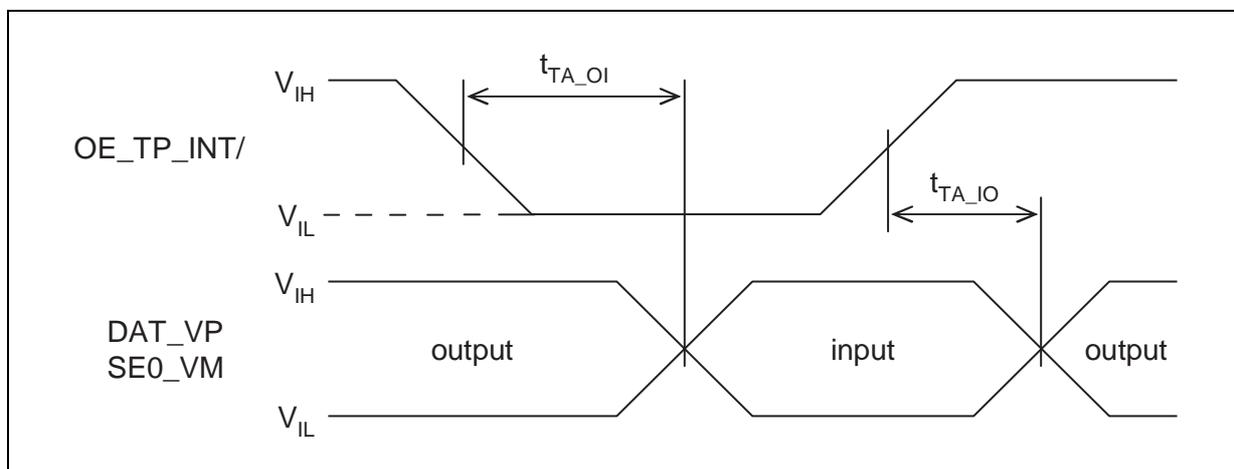


Figure 10. I<sup>2</sup>C BUS timing

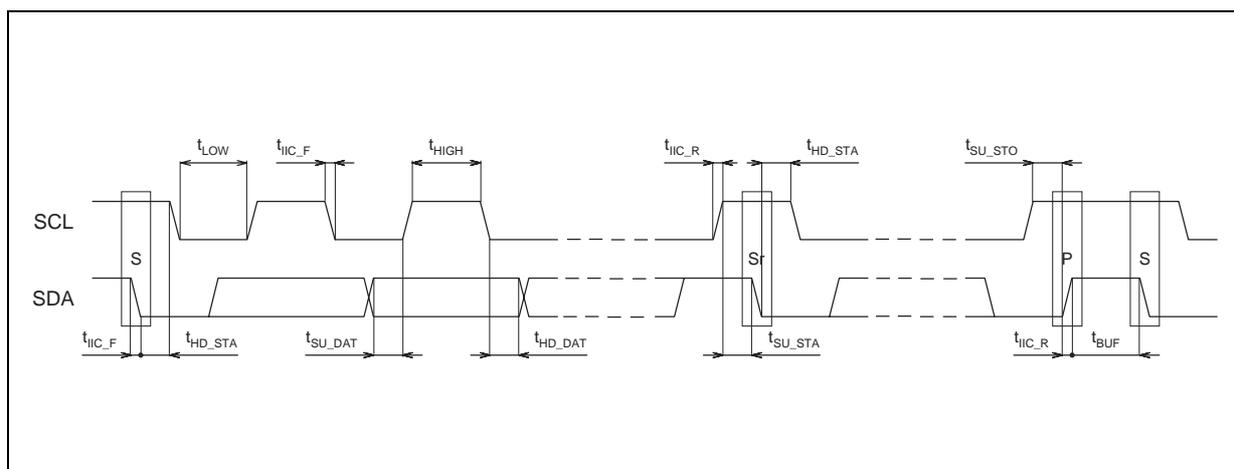
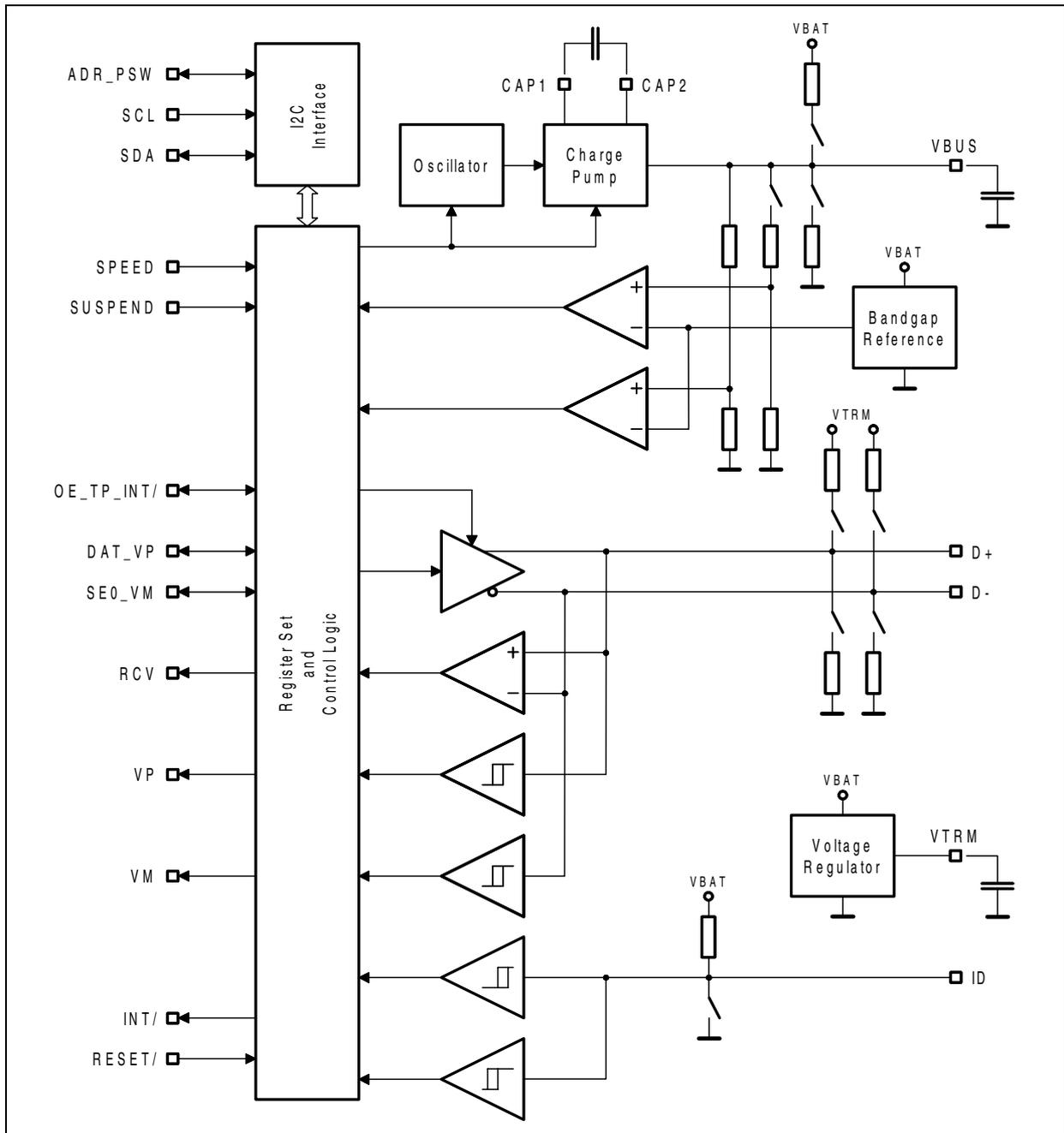


Figure 11. Block diagram



## 6 Block description

The STOTG04ES integrates a charge pump and comparators for the  $V_{BUS}$ , ID line detector and interrupt switch, differential data driver, differential and single-ended receivers, low dropout voltage regulator and control logic. The STOTG04ES provides a complete solution for connection of a digital USB OTG controller to the physical Universal Serial Bus.

### 6.1 Charge pump

The  $V_{BUS}$  line voltage is provided using the internal charge pump. It is capable of sourcing up to 35mA load current. The charge pump can be powered by voltage from 2.7V to 5.5V. It needs two capacitors for its operation: an external capacitor of 220nF connected between the CAP1 and CAP2 pins and a 4.7 $\mu$ F decoupling tank capacitor on the  $V_{BUS}$ . In case when an application needs higher current than 35mA, it is possible to provide it using an external charge pump or switch controlled by the ADR\_PSW pin.

### 6.2 $V_{BUS}$ Comparators

These comparators monitor the  $V_{BUS}$  voltage. They provide current status information for the  $V_{BUS}$  line.  $V_{BUS}$  valid status means that the voltage is above  $V_{BUS\_VLD}$ . Session valid status means that the  $V_{BUS}$  voltage is above  $V_{SES\_VLD}$  level.

### 6.3 Voltage regulator

An internal low-dropout voltage regulator provides power supply for the bus drivers and receivers. The regulator needs an external capacitor of 1 $\mu$ F on the  $V_{TRM}$  pin for its proper operation. The regulator can provide 3.3V or 2.75V output voltages according to the Operating Mode.

The regulator can be bypassed in case when the analog supply voltage is in the range of 3.0V (or 2.7V) to 3.6V. It is necessary to tie the  $V_{TRM}$  pin to the  $V_{BAT}$  power supply voltage to bypass the regulator.

### 6.4 ID Line detector

This block senses ID line status. It is capable of detecting three different line states:

- pin floating;
- pin tied to ground;
- pin grounded via a 140k $\Omega$  resistor.

The ID detector can also generate an interrupt by shorting the pin to ground.

### 6.5 Driver and receivers

The driver can operate in two different modes. It can act as a simple low-speed and full-speed differential USB driver or as two independent single-ended drivers in the UART mode.

This block contains one differential receiver for the USB operation mode and two single-ended receivers for USB signaling as well as UART receivers.

## 6.6 Control logic

This block controls the behavior of whole chip. It communicates with the external environment via the I<sup>2</sup>C serial bus. The control logic block consists of I<sup>2</sup>C slave interface, configuration and status registers, and some glue logic.

## 6.7 Modes of operation

The STOTG04ES can operate in two different power modes and in three operating modes. They can be controlled by logic signals and control registers.

### 6.7.1 Power modes

To reduce power consumption when there is no need for the USB function, the STOTG04 implements power-down mode. In this mode, the power consumption is strongly reduced. Power mode of the device can be controlled by bit suspend of the Control Register 1 or/and the SUSPEND pin as can be seen in table 8).

**Table 8. Power modes**

SUSPEND BIT	SUSPEND PIN	Power Mode
0	X	normal operation
X	0	
1	1	power-down

Although in power down mode all analog blocks should be switched off, some of them could be turned on by bits in the control registers having higher priority than suspend bit. In order to obtain minimum power consumption in power down mode the device must be configured as shown in Table 9. The digital part is fully static so that it almost does not consume power. All of the interrupts (except BDIS\_ACON) are fully operational in Power-down mode, as is the I<sup>2</sup>C interface.

**Table 9. Power down mode setup**

SUSPEND BIT	SUSPEND PIN	Control register 1	Control register 2	Control register 3
1	1	X1X0XX0-	00XX00X0	-XXXX0XX

X = Don't care  
 - = Reserved  
 Bit order: 0...7

### 6.7.2 USB Modes

The STOTG04ES transceiver has two basic USB operational modes. These modes define how the digital IO pins of the transceiver will be used. Independently of USB operating mode, some signals always have the same function (see Table 10).

**Table 10. Digital interface signals**

Signal	Function
RCV	Differential receiver output
VP	D+ single-ended receiver output
VM	D- single-ended receiver output
OE_TP_INT/	Output enable signal of the differential driver

The RCV signal is active in the VP\_VM mode only. Its output driver is controlled by the OE\_TP\_INT/ signal. Operating modes are described below. The meanings of the DAT\_VP and SE0\_VM signals depend on the mode of operation. Both of these signals can be bidirectional or unidirectional. The direction is controlled by bidi\_en Bit of Control Register 3 (described later). When these signals are bidirectional, the direction is controlled by the OE\_TP\_INT/ signal (see Tables 11 and 12).

The actual mode of operation is controlled by the dat\_se0 Bit of Control Register 1 (see Tables 11 and 12)

**Table 11. DAT\_SE0 (dat\_se0 = 1)**

bidi_en	OE/*	DAT_VP	SE0_VM
1	0	Differential driver input	SE0 driver input
	1	Differential receiver output	SE0 detector output
0	X	Differential driver input	SE0 driver input

**Table 12. VP\_VM (dat\_se0 = 0)**

bidi_en	OE/*	DAT_VP	SE0_VM
1	0	D+ driver input	D- driver input
	1	D+ receiver output	D- receiver output
0	X	D+ driver input	D- driver input

\* State of the OE\_TP\_INT/ signal.

In the USB mode of operation it is necessary to control the rise and fall times of the transmission driver. These times are different for low-speed and full-speed USB settings. Selection of actual USB speed can be done using the bit speed of Control Register 1 or/and the SPEED pin (see table 13).

**Table 13. USB Speed Selection**

speed bit	SPEED Pin	USB Mode
0	X	low-speed
X	0	
1	1	full-speed

### 6.7.3 UART Mode

The actual mode of operation is selectable by the transp\_en and uart\_en Bits of Control Register 1 (see table 14).

**Table 14. Transceiver modes**

transp_en	uart_en	STOTG04 Mode
0	0	USB
0	1	UART
1	0	FORBIDDEN
1	1	UART (1)

(1) In reality, it is not possible to set both these bits at the same time. In this case, only uart\_en bit will remain set.

In the UART mode it is possible to select driver direction on both the D+ and D- pins. The selection is done using the bdir[1] and bdir[0] Bits of Control Register 3 (see table 15).

**Table 15. UART drivers direction**

<b>bdir[1]</b>	<b>bdir[0]</b>	<b>DAT_VP ↔ D+</b>	<b>SE0_VM ↔ D-</b>
0	0	→	→
0	1	→	←
1	0	←	→
1	1	←	←

### 6.7.4 Audio mode

In this mode the transceiver has to release all of its drivers and pull-up/pull-down resistors on the D+, D- and ID pins, leaving them in a high impedance state. This allows these lines to be used for transmission of audio signals. The transceiver should not provide voltage on its V<sub>BUS</sub> output in this mode. Conditions described in Table 16 force the transceiver into the audio mode.

**Table 16. Audio mode setup**

<b>transp_en bit</b>	<b>uart_en bit</b>	<b>OE_TP_INT/ signal</b>	<b>Control Register 2</b>
0	0	1	00000000

## 6.8 Registers

The STOTG04ES transceiver device is controlled using register settings (see Table 17). These registers can be set and read via the I<sup>2</sup>C bus.

**Table 17. Register set**

<b>Register</b>	<b>Size (bits)</b>	<b>Acc<sup>(1)</sup></b>	<b>Addr<sup>(2)</sup></b>	<b>Description</b>
Vendor ID	16	r	00h	STMicroelectronics ID (0483h) - LSB first
Product ID	16	r	02h	ID of the STOTG04 (A0C4h) - LSB first
Control 1	8	r/s/c	04h 05h	First Control Register
Control 2	8	r/s/c	06h 07h	Second Control Register
Control 3	8	r/s/c	12h 13h	Third Control Register
Interrupt Source	8	r	08h	Current state of signals generating interrupts
Interrupt Latch	8	r/s/c	0Ah 0Bh	Latched source that generated interrupt
Interrupt Mask False	8	r/s/c	0Ch 0Dh	Enables interrupts on falling edge
Interrupt Mask True	8	r/s/c	0Eh 0Fh	Enables interrupts on rising edge

(1) Access type can be: read (r), set (s), clear (c).

(2) The first address is to set, the second one to clear bits.

When writing to the set address, any “1” will set the associated Bit to logic “1”. When writing to the clear address, any “1” will set the associated Bit to logic “0”. It is possible to read from any address, whether it is a set or clear address. See Tables 18, 19, 20, 21 for bit setting details.

**Table 18. Control register 1**

Name	Bit	R <sup>(1)</sup>	Description
Speed	0	1	0 = low-speed mode 1 = full-speed mode
Suspend	1	1	0 = normal operation 1 = power-down mode
dat_se0	2	0	0 = VP_VM mode 1 = DAT_SE0 mode
transp_en	3	0	Reserved. For testing purpose
bdis_acon_en	4	0	Enable A-device to connect if B-device disconnect detected
oe_int_en	5	0	When set and suspend = 1, then OE_TP_INT/ becomes interrupt output
uart_en	6	0	Enables UART mode (higher priority than transp_en bit) and 2.7V voltage regulation
	7		Reserved

(1) State of the bit after reset.

Setting the bdis\_acon\_en bit enables automatic switching of the D+ pull-up resistor when the device receives an SE0 longer than half of the bit period. This function should not be used in low-speed operation.

**Table 19. Control register 2**

Name	Bit	R	Description
dp_pull-up	0	0	Connect D+ pull-up
dm_pull-up	1	0	Connect D- pull-up
dp_pull-down	2	1	Connect D+ pull-down
dm_pull-down	3	1	Connect D- pull-down
id_gnd_drv	4	0	Connect ID pin to ground
vbus_drv	5	0	Provide power to V <sub>BUS</sub>
vbus_dischrg	6	0	Discharge V <sub>BUS</sub> through a resistor to ground
vbus_chrg	7	0	Charge V <sub>BUS</sub> through a resistor

It is not possible to set vbus\_drv, vbus\_dischrg and vbus\_chrg at the same time; the bit having higher priority will remain set while the others will be cleared. Vbus\_drv has higher priority than vbus\_dischrg which has higher priority than vbus\_chrg.

**Table 20. Control register 3**

Name	Bit	R	Description
	0	0	Reserved
rec_bias_en	1	0	Enables transmitter bias even during USB receive
bidi_en	2	1	When set, then DAT_VP and SE0_VM pins become bidirectional otherwise they are inputs only
bdir[0]	3	0	Direction of the drivers between DAT_VP↔DP and
bdir[1]	4	1	SE0_VM↔DM in the UART mode
audio_en	5	0	Enables car-kit interrupt detector
psw_en	6	0	Enables external charge pump control on the ADR_PSW pin
	7	0	Reserved

**Table 21. Interrupt registers (\*)**

Name	Bit	R	Description
vbus_vld	0	0	A-device V <sub>BUS</sub> valid comparator
sess_vld	1	0	Session valid comparator
dp_hi	2	0	D+ pin is asserted high during SRP
id_gnd	3	0	ID pin grounded
dm_hi	4	0	D- pin is asserted high
id_float	5	0	ID pin floating
bdis_acon	6	0	Set when bdis_acon_en bit is set and transceiver asserts dp_pull-up after detecting B-device disconnect
cr_int	7	0	Car-kit interrupt

(\*) Bit order is the same for all four interrupt related registers. Meaning of each register is described in Table 17.

## 6.9 I<sup>2</sup>C Bus interface

All of the STOTG04 transceiver registers are accessible through the I<sup>2</sup>C bus (see Figure 12). The device contains a slave controller which provides communication with an external master. The I<sup>2</sup>C interface consists of three pins:

- SDA (Serial Data);
- SCL (Serial Clock);
- ADR\_PSW (is the LSB of the device address).

### 6.10 Device address

The USB-OTG transceiver has following 7-bit I<sup>2</sup>C device address:

0	1	0	1	1	0	adr
---	---	---	---	---	---	-----

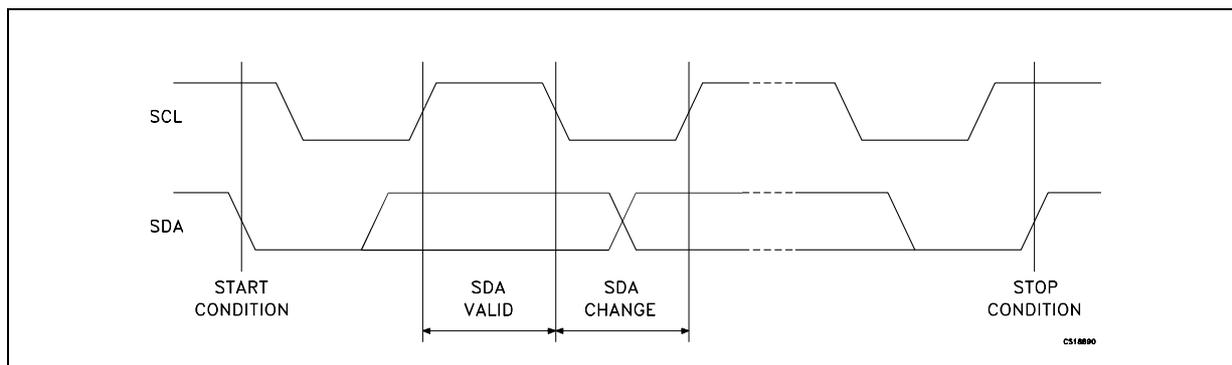
The adr bit represents current state of the ADR\_PSW device pin. It means that the address can be either 2Ch or 2Dh according to the ADR\_PSW pin.

### 6.11 Bus protocol

Any device that sends data to the bus is defined as the transmitter. Any device that reads the data is the receiver. The device that controls data transfers is the bus master, while the transmitter or receiver is the slave device. The master initiates data transfers and provides the serial clock. The STOTG04 is always the slave device.

Operation of the I<sup>2</sup>C bus is described by following figure 12.

**Figure 12. Basic operation of the I<sup>2</sup>C Bus**



**Start condition** is identified by a falling edge of the SDA signal while the SCL is stable at high level. The start condition must precede any data transfer on the bus.

**Stop condition** is identified by a rising edge of the SDA signal while the SCL is stable at high level. The stop condition terminates any communication between device and master.

The **acknowledge bit** is used to indicate a successful byte transfer. The bus transmitter releases the SDA line after sending eight data bits. During the ninth clock period the receiver pulls the SDA line low to acknowledge the receipt of the eight data bits. If the receiver is a slave device and it does not generate acknowledge bit then the bus master can generate the stop condition in order to abort the transfer.

Below is described format of I<sup>2</sup>C commands. All tables use common format and symbols. Every data word consists of eight bits with most significant bit first and least significant bit last.

Symbols used in the tables are:

- S – start condition
- P – stop condition
- A – acknowledge bit
- N – negative acknowledge

**WRITE Command** to the transceiver device is described by following table. It is possible to write into several consecutive registers during one write command.

S	Device address	0	A	Reg. address K	A		
Data (K)	A	Data (K+1)	A	..	Data (K+N)	A	P

**READ command** consists of dummy write to set proper address of a register followed by real read sequence.

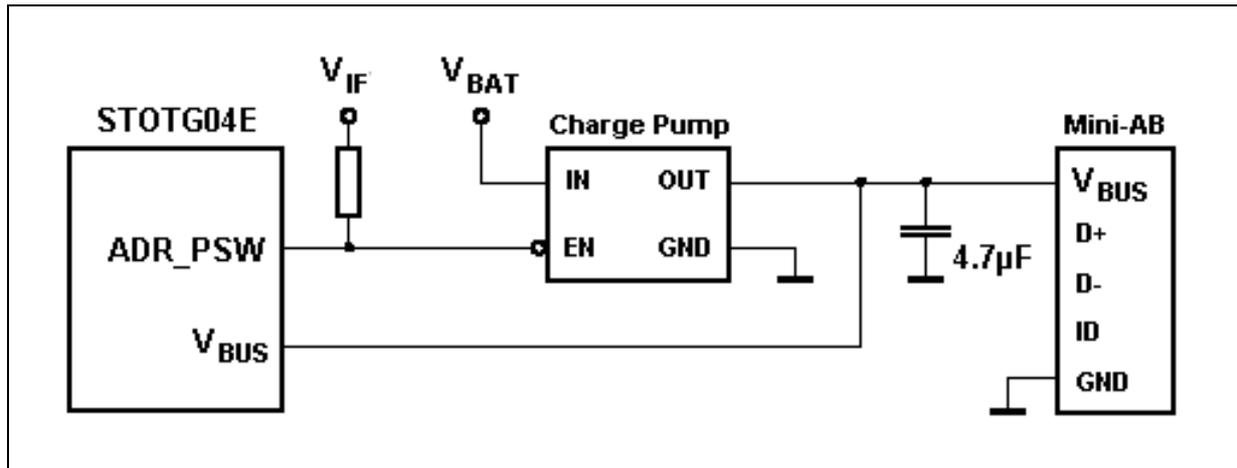
S	Device address	0	A	Reg. address K	A	P	
S	Device address	1	A	Data (K)	A		
Data (K+1)	A	Data (K+2)	A	...	Data (K+N)	N	P

## 6.12 External charge pump switch

The ADR\_PSW pin has two functions. State of this pin is always latched into a register on the rising edge of the RESET/ signal. The latched value is used as a least significant bit of the I<sup>2</sup>C address. After the address is latched, this pin can be set as an output by setting the PSW\_EN bit of the Control Register 3. Output value of the pin is low when the pin is high during reset; otherwise the output is high.

Example connection of an external charge pump is shown in following figure. When the charge pump control signal would be active high, the ADR\_PSW pin should be pulled down instead of high.

Figure 13. External charge pump application

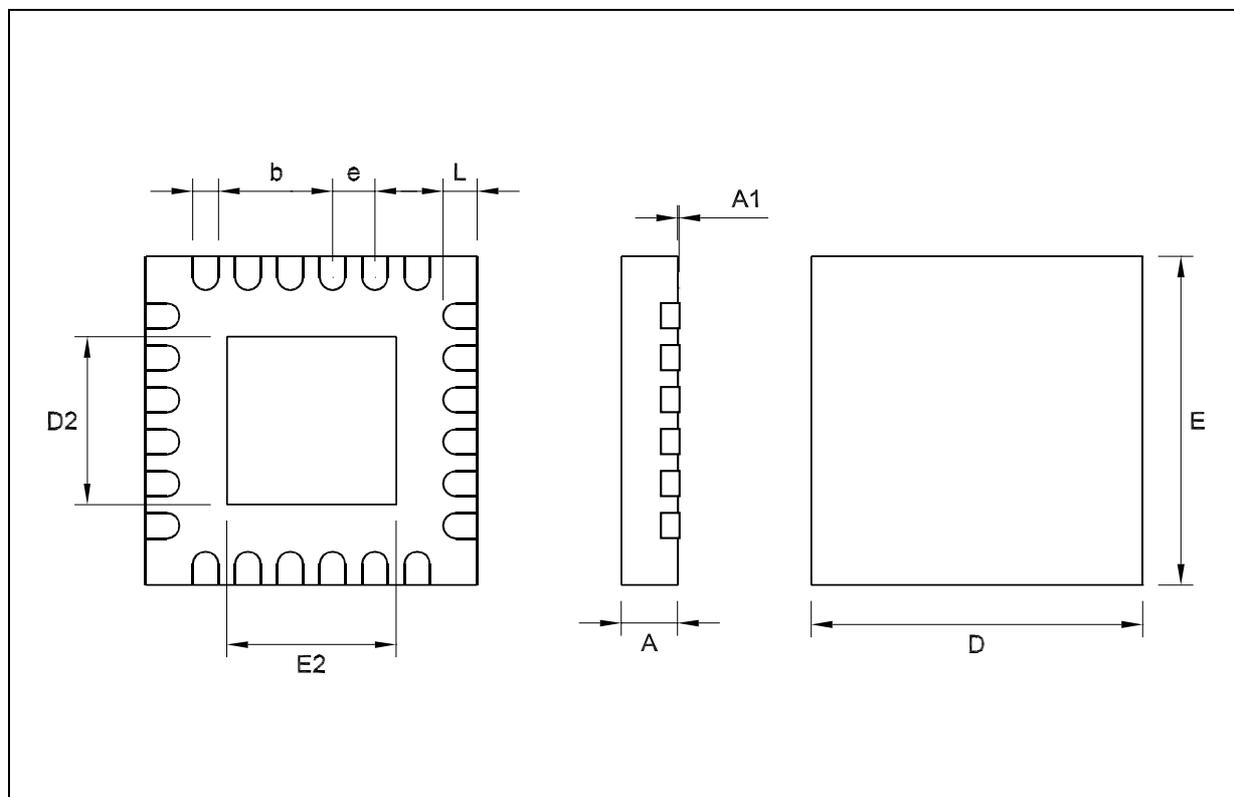


## 7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com).

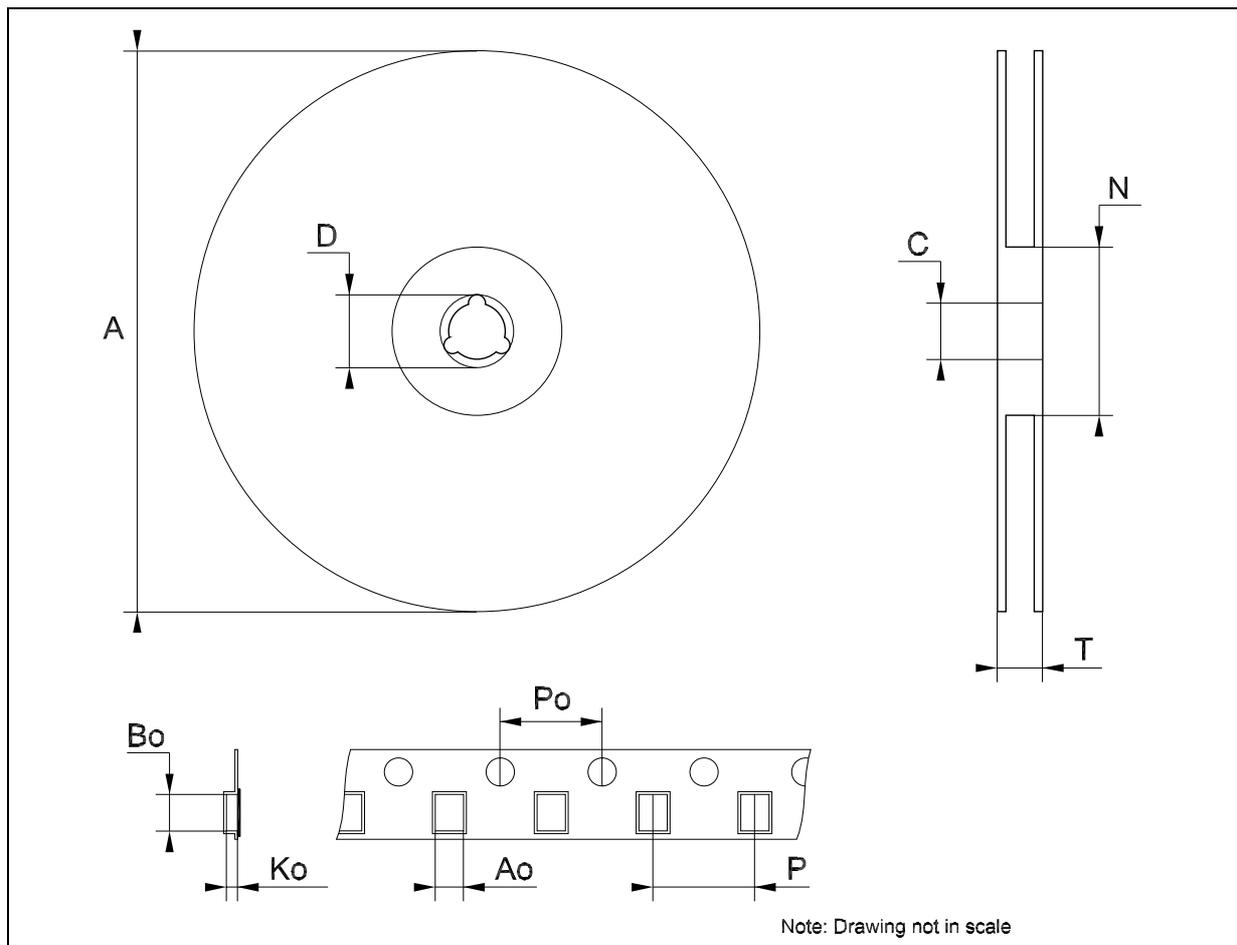
**QFN24 (4x4) MECHANICAL DATA**

DIM.	mm.			mils		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.00			39.4
A1	0.00		0.05	0.0		2.0
b	0.18		0.30	7.1		11.8
D	3.9		4.1	153.5		161.4
D2	1.95		2.25	76.8		88.6
E	3.9		4.1	153.5		161.4
E2	1.95		2.25	76.8		88.6
e		0.50			19.7	
L	0.40		0.60	15.7		23.6



**Tape & Reel QFNxx/DFNxx (4x4) MECHANICAL DATA**

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	99		101	3.898		3.976
T			14.4			0.567
Ao		4.35			0.171	
Bo		4.35			0.171	
Ko		1.1			0.043	
Po		4			0.157	
P		8			0.315	



## 8 Revision history

**Table 22. Revision history**

<b>Date</b>	<b>Revision</b>	<b>Description of Change</b>
13-Jan-2006	1	First Release.
01-Feb-2006	2	Mistake on Table 1.
17-Oct-2006	3	Added details in paragraph 6.7.1, comments to table 19 and description in paragraph 6.12.

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